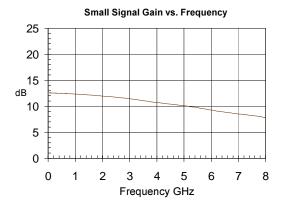


# **Product Description**

Sirenza Microdevices' NGA-186 is a high performance Gallium Arsenide Heterojunction Bipolar Transistor MMIC Amplifier. Designed with InGaP process technology for improved reliability, a Darlington configuration is utilized for broadband performance up to 6 Ghz. The heterojunction increases breakdown voltage and minimizes leakage current between junctions. Cancellation of emitter junction non-linearities results in higher suppression of intermodulation products.



# **NGA-186**

DC-6000 MHz, Cascadable GaAs HBT MMIC Amplifier



# **OBSOLETE**

See Application Note AN-059 for Alternates

#### **Product Features**

- 12.0dB Gain, 14.7 dBm P1dB at 1950Mhz
- Cascadable 50 ohm: 1.2:1 VSWR
- Operates from Single Supply
- Low Thermal Resistance Package
- Unconditionally Stable

# **Applications**

- PA Driver Amplifier
- Cellular, PCS, GSM, UMTS
- IF Amplifier
- Wireless Data, Satellite

Symbol	Parameter	Units	Frequency	Min.	Тур.	Max.
P <sub>1dB</sub>	Output Power at 1dB Compression	dBm	850 MHz 1950 MHz 2400 MHz		14.6 14.7 14.9	
OIP <sub>3</sub>	Output Third Order Intercept Point	dBm	850 MHz 1950 MHz 2400 MHz		32.9 31.7 31.1	
G	Small Signal Gain	dB	850 MHz 1950 MHz 2400 MHz	11.2	12.4 12.0 11.8	13.6
Bandwidth	Determined by Return Loss (<-10dB)	MHz			5600	
	Input VSWR	-	DC - 5000 MHz		1.2:1	
	Output VSWR	-	DC - 5000 MHz		1.2:1	
NF	Noise Figure	dB	2000 MHz		4.0	
$V_{D}$	Device Operating Voltage	V		3.6	4.1	4.6
I <sub>D</sub>	Device Operating Current	mA		45	50	55
R <sub>TH</sub> , j-l	Thermal Resistance (junction to lead)	°C/W			120	

**Test Conditions:** 

 $V_s = 8 V$  $R_{out} = 75 Ohms$   $I_{D} = 50 \text{ mA Typ.}$  $T_{L} = 25^{\circ}\text{C}$  OIP<sub>3</sub> Tone Spacing = 1 MHz, Pout per tone = 0 dBm  $Z_s = Z_1 = 50$  Ohms

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### **⚠** OBSOLETE

# NGA-186 DC-6.0 GHz 4.1V GaAs HBT

# Key parameters, at typical operating frequencies:

Typical		Test Condition	
Parameter	25°C	Unit	$(I_D = 50 \text{mA}, \text{ unless otherwise noted})$
500 MHz			
Gain	12.5	dB	
Output IP3	32.6	dBm	Tone spacing = 1 MHz, Pout per tone = 0dBm
Output P1dB	14.7	dBm	
Input Return Loss	30.1	dB	
Isolation	16.5	dB	
850 MHz			
Gain	12.4	dB	
Output IP3	32.9	dBm	Tone spacing = 1 MHz, Pout per tone = 0dBm
Output P1dB	14.6	dBm	
Input Return Loss	29.9	dB	
Isolation	16.5	dB	
1950 MHz			
Gain	12.0	dB	
Output IP3	31.7	dBm	Tone spacing = 1 MHz, Pout per tone = 0dBm
Output P1dB	14.7	dBm	
Input Return Loss	27.6	dB	
Isolation	16.4	dB	
2400 MHz			
Gain	11.8	dB	
Output IP3	31.1	dBm	Tone spacing = 1 MHz, Pout per tone = 0dBm
Output P1dB	14.9	dBm	
Input Return Loss	25.3	dB	
Isolation	16.4	dB	

#### **Absolute Maximum Ratings**

	•
Parameter	Absolute Limit
Max. Device Current (I <sub>D</sub> )	110 mA
Max. Device Voltage (V <sub>D</sub> )	6 V
Max. RF Input Power	+10 dBm
Max. Junction Temp. (T <sub>J</sub> )	+150°C
Operating Temp. Range (T <sub>L</sub> )	-40°C to +85°C
Max. Storage Temp.	+150°C

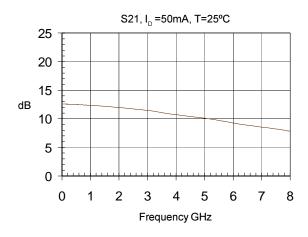
Operation of this device beyond any one of these limits may cause permanent damage. For reliable continous operation, the device voltage and current must not exceed the maximum operating values specified in the table on page one.

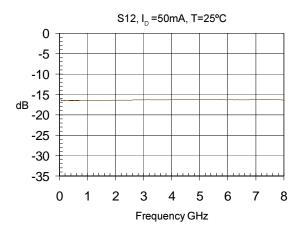
Bias Conditions should also satisfy the following expression:  $I_{D}V_{D} < (T_{J} - T_{L}) / R_{TH}$ . j-I

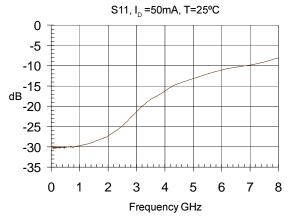


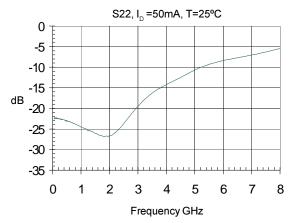
# OBSOLETE NGA-186 DC-6.0 GHz 4.1V GaAs HBT

#### Electrical Specifications at Ta = 25°C







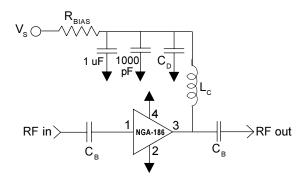


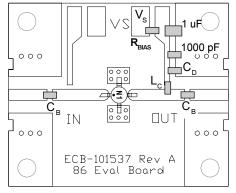


#### **⚠** OBSOLETE

# NGA-186 DC-6.0 GHz 4.1V GaAs HBT

### **Basic Application Circuit**





#### Part Identification Marking

The part will be marked with an "N1" designator on the top surface of the package.



# Caution: ESD sensitive Appropriate precautions in handling, packaging and testing devices must be observed.

#### **Application Circuit Element Values**

Reference		Frequency (Mhz)					
Designator	500	850	1950	2400	3500		
C <sub>B</sub>	220 pF	100 pF	68 pF	56 pF	39 pF		
C <sub>D</sub>	100 pF	68 pF	22 pF	22 pF	15 pF		
L <sub>c</sub>	68 nH	33 nH	22 nH	18 nH	15 nH		

Recommended Bias Resistor Values for $I_D$ =50mA $R_{BIAS}$ =( $V_S$ - $V_D$ ) / $I_D$				
Supply Voltage(V <sub>s</sub> )	6 V	8 V	10 V	12 V
R <sub>BAS</sub>	39 Ω	75 Ω	120 Ω	160 Ω
Note: R provides DC bias stability over temperature.				

#### **Mounting Instructions**

- 1. Use a large ground pad area under device pins 2 and 4 with many plated through-holes as shown.
- We recommend 1 or 2 ounce copper. Measurements for this data sheet were made on a 31 mil thick FR-4 board with 1 ounce copper on both sides.

Pin#	Function	Description
1	RF IN	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.
2, 4	GND	Connection to ground. Use via holes for best performance to reduce lead inductance as close to ground leads as possible.
3	RF OUT/ BIAS	RF output and bias pin. DC voltage is present on this pin, therefore a DC blocking capacitor is necessary for proper operation.

#### Part Number Ordering Information

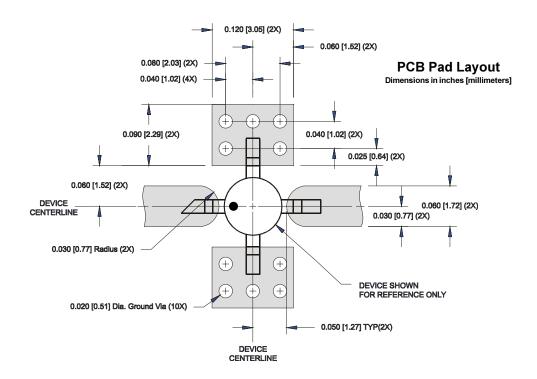
Part Number	Reel Size	Devices/Reel		
NGA-186	7"	1000		

522 Almanor Ave., Sunnyvale, CA 94085

Phone: (800) SMI-MMIC

#### **⚠** OBSOLETE

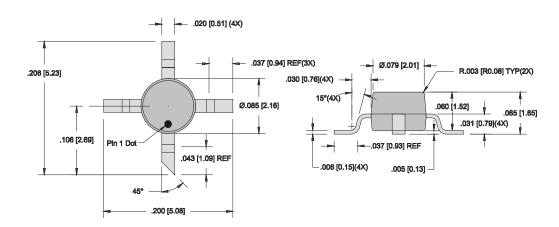
# NGA-186 DC-6.0 GHz 4.1V GaAs HBT



## **Nominal Package Dimensions**

Dimensions in inches [millimeters]

Refer to drawing posted at www.sirenza.com for tolerances.



Phone: (800) SMI-MMIC